

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant:

Leonel R. Arana et al.

Art Unit:

2813

Serial No.:

10/807,836

Examiner:

Heather Anne Doty

Filed:

March 24, 2004

Vacuum Sensor

Docket:

ITL.1133US

P19113

For:

Microfabricated Hot Wire

9999999999

Assignee:

Intel Corporation

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

REPLY TO PAPER NO. 20051108

Sir:

In response to the office action mailed November 16, 2005, please amend the abovereferenced patent application as follows:

Date of Deposit: January 12, 2006

I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated above and is addressed to the